

**Absolute Maximum Ratings** (Voltage relative to GND, @T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Voltage	V <sub>IN</sub>	-0.3 to 100	V
Continuous Input & Output Current	I <sub>IN</sub> , I <sub>OUT</sub>	400	mA
Peak Pulsed Input & Output Current	I <sub>IM</sub> , I <sub>OM</sub>	2	A
Maximum Voltage applied to V <sub>OUT</sub>	V <sub>OUT(MAX)</sub>	Smaller of V <sub>IN</sub> +8.2V or 14.5V	V

**Maximum Current at V<sub>IN</sub> = 48V** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Continuous Output Current	(Note 7)	I <sub>OUT</sub>	42	mA
Pulsed Output Current	(Note 8)	I <sub>OM</sub>	800	mA
	(Note 9)		160	

**Thermal Characteristics**

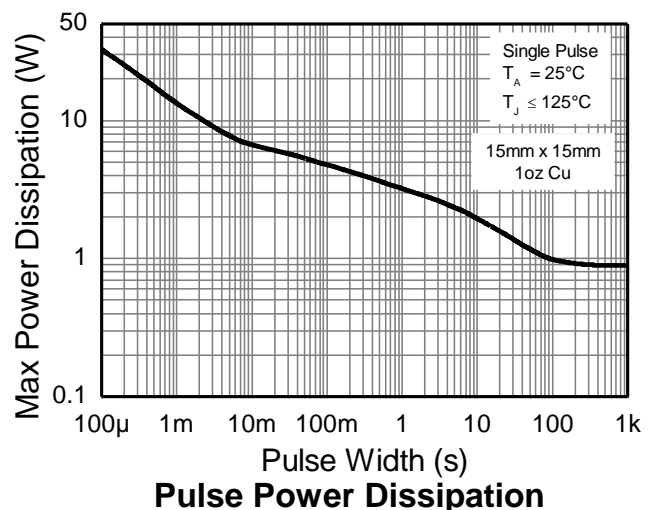
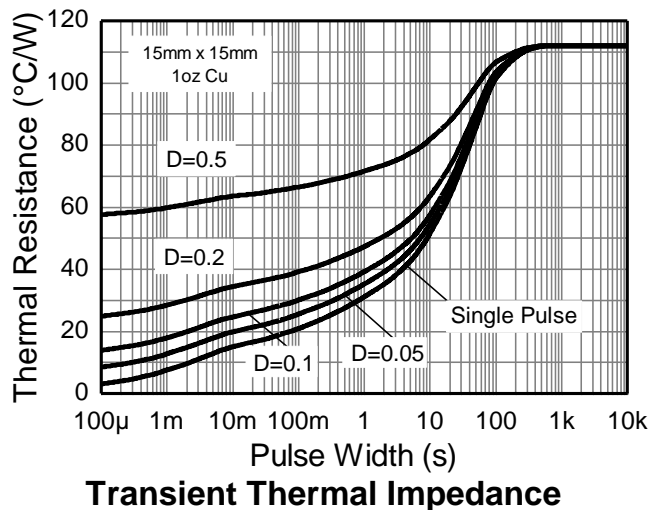
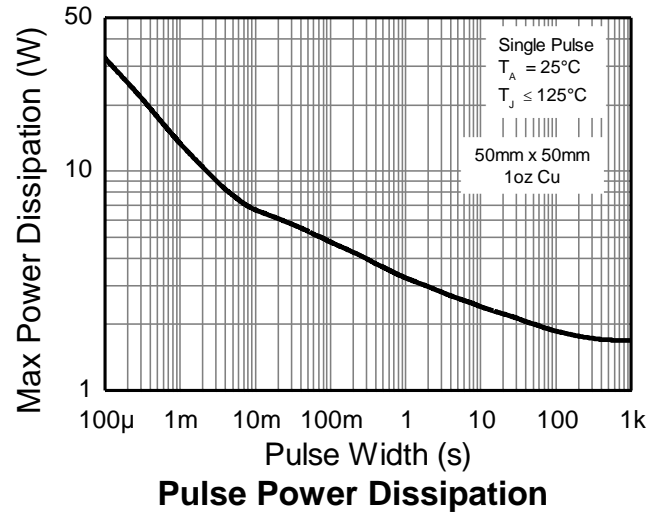
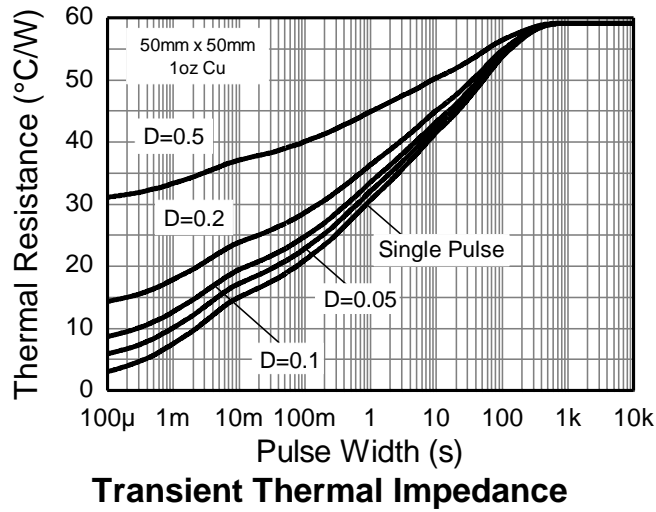
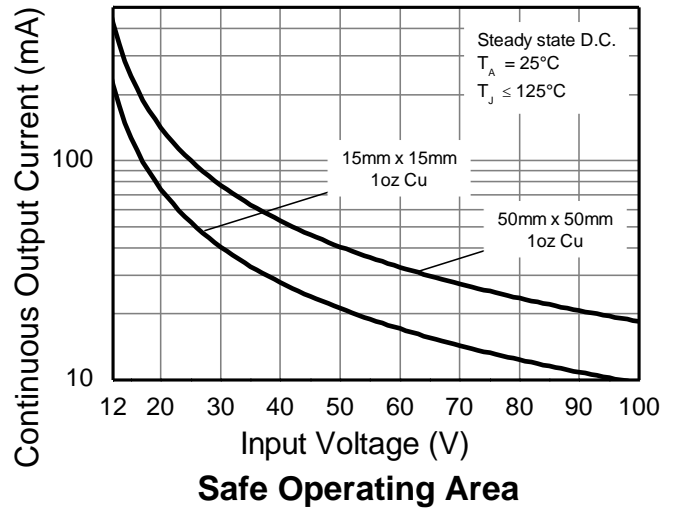
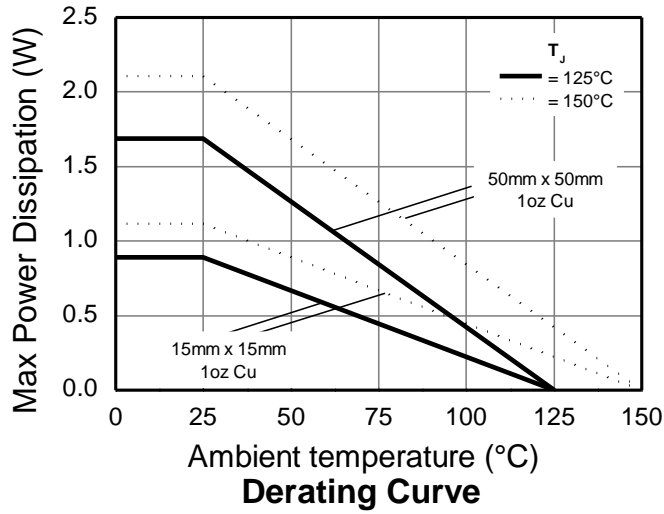
Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	P <sub>D</sub>	1.7	W
	(Note 6)		0.89	
Thermal Resistance, Junction to Ambient	(Note 5)	R <sub>θJA</sub>	59	°C/W
	(Note 6)		112	
Thermal Resistance, Junction to Lead	(Note 10)	R <sub>θJL</sub>	20	
Thermal Resistance, Junction to Case	(Note 10)	R <sub>θJC</sub>	15.7	
Recommended Operating Junction Temperature Range		T <sub>J</sub>	-40 to +125	°C
Maximum Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**ESD Ratings** (Note 11)

Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the exposed V<sub>IN</sub> pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
  - Same as Note 5, except mounted on 15mm x 15mm 1oz copper.
  - Same as Note 5, whilst operating at V<sub>IN</sub> = 48V. Refer to Safe Operating Area for other Input Voltages.
  - Same as Note 5, except measured with a single pulse width = 100μs and V<sub>IN</sub> = 48V.
  - Same as Note 5, except measured with a single pulse width = 10ms and V<sub>IN</sub> = 48V.
  - R<sub>θJL</sub> = Thermal resistance from junction to solder-point (on the exposed V<sub>IN</sub> pad). R<sub>θJC</sub> = Thermal resistance from junction to the top of case.
  - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

## Thermal Characteristics and Derating Information

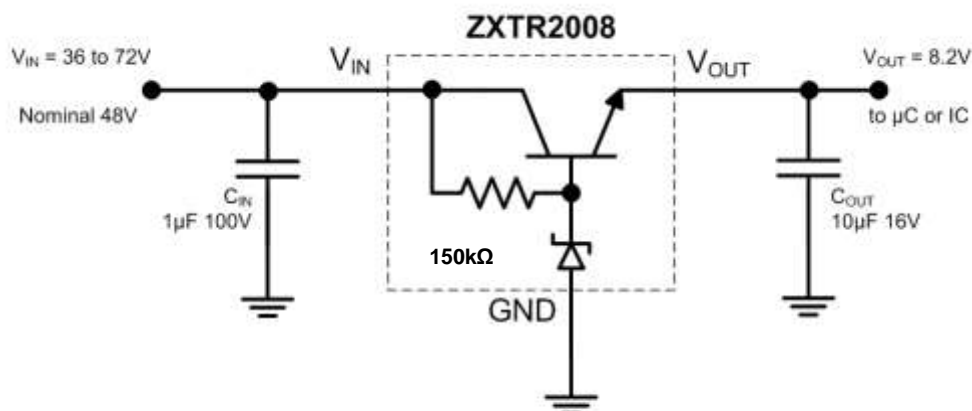


## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Output Voltage (Note 12)	V <sub>OUT</sub>	7.38	8.2	9.02	V	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Line Regulation (Notes 12 & 13)	ΔV <sub>OUT</sub>	—	10	300	mV	V <sub>IN</sub> = 12 to 100V, I <sub>OUT</sub> = 15mA
Temperature Coefficient	ΔV <sub>OUT</sub> /ΔT	—	10	—	mV/°C	T <sub>J</sub> = -40°C to +125°C V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Load Regulation (Notes 12 & 14)	ΔV <sub>OUT</sub>	—	-180 -250	-350 -500	mV	I <sub>OUT</sub> = 0.1 to 30mA, V <sub>IN</sub> = 48V I <sub>OUT</sub> = 0.1 to 100mA, V <sub>IN</sub> = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	V <sub>IN(MIN)</sub>	12	—	—	V	—
Quiescent Current	I <sub>Q</sub>	—	275 650	500 900	μA	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 10μA V <sub>IN</sub> = 100V, I <sub>OUT</sub> = 10μA
Power Supply Rejection Ratio	ΔV <sub>IN</sub> /ΔV <sub>OUT</sub>	—	38	—	dB	C <sub>OUT</sub> = 100nF, I <sub>OUT</sub> = 15mA, V <sub>OUT</sub> = 8.2V, V <sub>IN</sub> = 12 to 100V, f = 100Hz

- Notes:
- 12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%
  - 13. Line regulation ΔV<sub>OUT</sub> = V<sub>OUT</sub>(@ V<sub>IN</sub> = 100V) – V<sub>OUT</sub>(@ V<sub>IN</sub> = 12V)
  - 14. Load regulation ΔV<sub>OUT</sub> = V<sub>OUT</sub>(@ I<sub>OUT</sub> = 30mA) – V<sub>OUT</sub>(@ I<sub>OUT</sub> = 0.1mA)  
ΔV<sub>OUT</sub> = V<sub>OUT</sub>(@ I<sub>OUT</sub> = 100mA) – V<sub>OUT</sub>(@ I<sub>OUT</sub> = 0.1mA)

## Typical Application Circuit

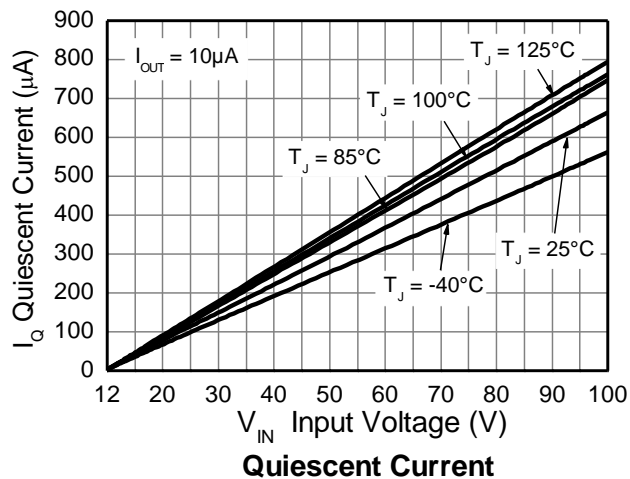
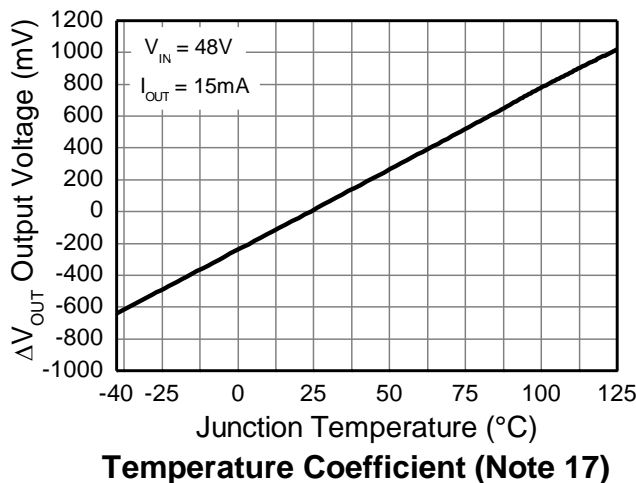
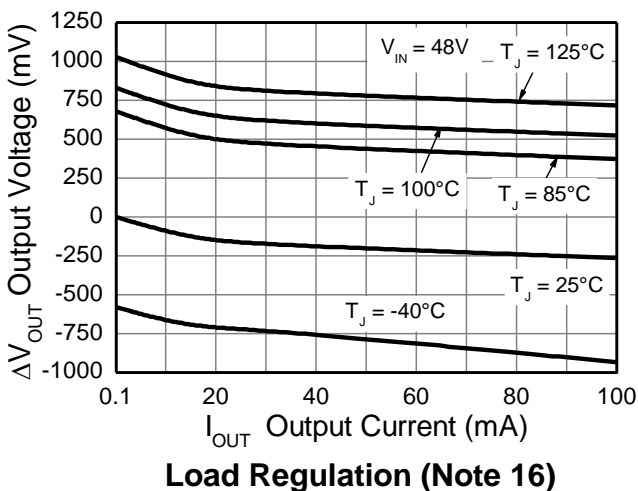
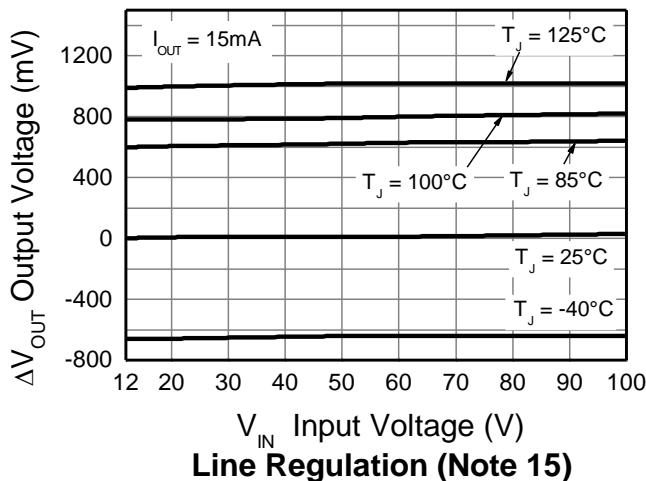
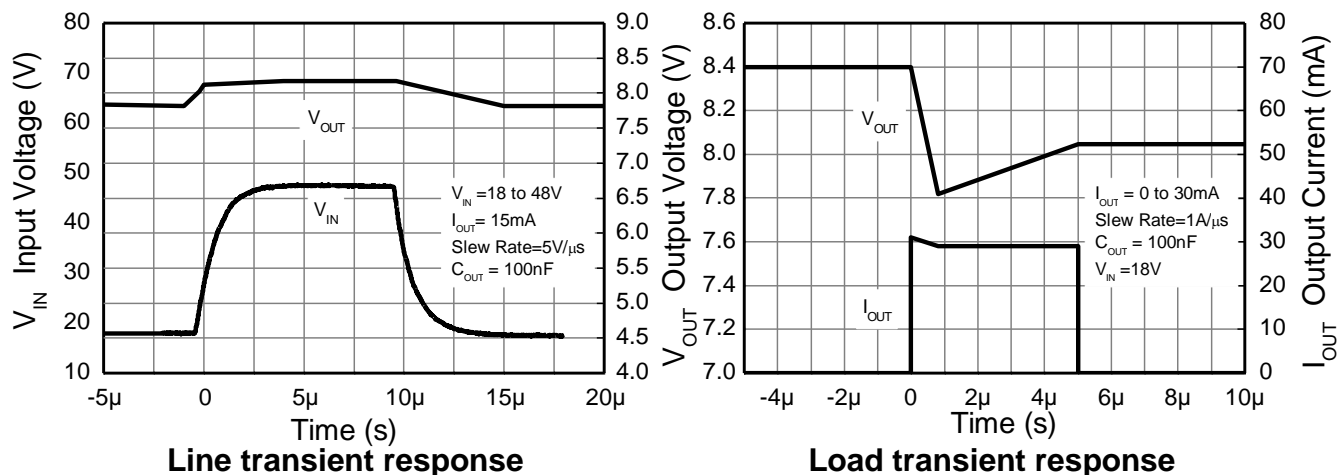


Example of an 8.2V regulated supply from a nominal 48V for powering a Controller IC.

## Pin Functions

Pin Name	Pin Function	Notes
V <sub>IN</sub>	Input Supply	Input voltage can vary from -0.3V to 100V with respect to GND; for V <sub>OUT</sub> regulated then 12V ≤ V <sub>IN</sub> ≤ 100V. It is recommended to connect a 1μF capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
V <sub>OUT</sub>	Voltage Output	Outputs a regulated 8V when 12V ≤ V <sub>IN</sub> ≤ 100V. When V <sub>IN</sub> < 12V, then V <sub>OUT</sub> maximum = V <sub>IN</sub> – 1.5V. The pin can be pulled high to a maximum of +14V with respect to GND, or +8V with respect to V <sub>IN</sub> , whichever is lower. It is recommended to connect a 10μF capacitor to GND and a minimum of 10μA to be drawn from V <sub>OUT</sub> to maintain regulation.

**Typical Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

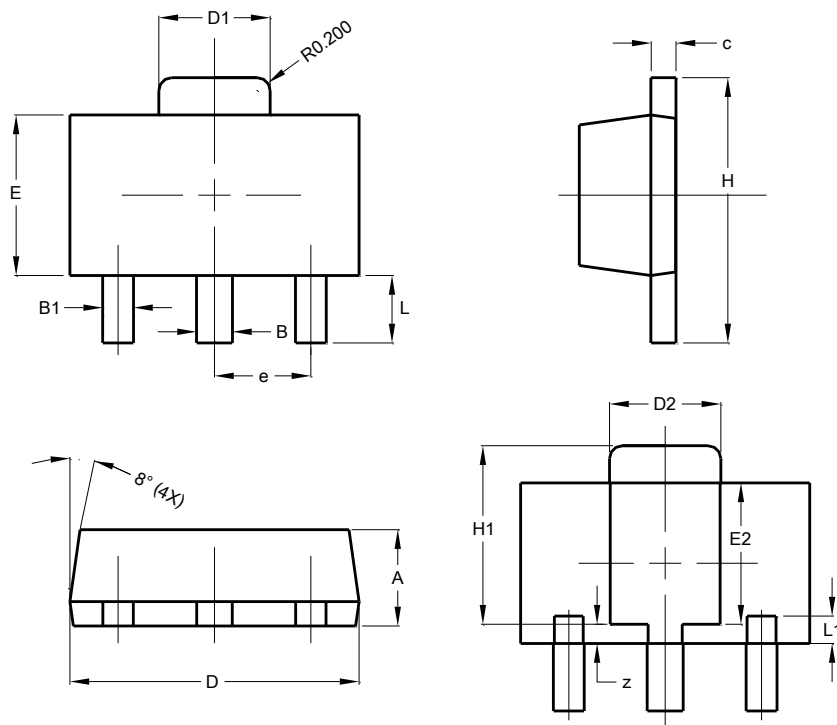


- Notes:
- 15. Line regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 12\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$
  - 16. Load regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 48\text{V}, I_{OUT} = 0.1\text{mA}, T_J = +25^\circ\text{C})$
  - 17. Temperature Coefficient  $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 48\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT89**

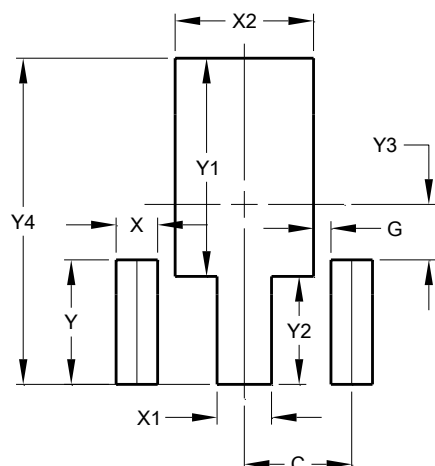


SOT89			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
B	0.50	0.62	0.56
B1	0.42	0.54	0.48
c	0.35	0.43	0.38
D	4.40	4.60	4.50
D1	1.62	1.83	1.733
D2	1.61	1.81	1.71
E	2.40	2.60	2.50
E2	2.05	2.35	2.20
e	-	-	1.50
H	3.95	4.25	4.10
H1	2.63	2.93	2.78
L	0.90	1.20	1.05
L1	0.327	0.527	0.427
z	0.20	0.40	0.30
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT89**



Dimensions	Value (in mm)
C	1.500
G	0.244
X	0.580
X1	0.760
X2	1.933
Y	1.730
Y1	3.030
Y2	1.500
Y3	0.770
Y4	4.530

**IMPORTANT NOTICE**

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2017, Diodes Incorporated

**www.diodes.com**